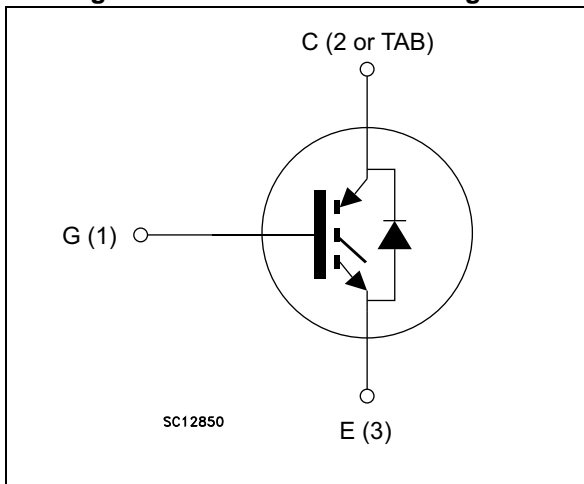


Figure 1. Internal schematic diagram



Features

- 10 μ s of short-circuit withstand time
- $V_{CE(sat)} = 1.55$ V (typ.) @ $I_C = 15$ A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and fast recovery antiparallel diode

Applications

- Industrial drives
- UPS
- Solar
- Welding

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the S series of 1200 V IGBTs which is tailored to maximize efficiency of low frequency industrial systems. Furthermore, a positive $V_{CE(sat)}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packing
STGW15S120DF3	G15S120DF3	TO-247	Tube
STGWA15S120DF3	G15S120DF3	TO-247 long leads	Tube

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
3	Electrical characteristics curves	6
4	Test circuits	12
5	Package information	13
5.1	TO-247, STGW15S120DF3	13
5.2	TO-247 long leads, STGWA15S120DF3	15
6	Revision history	17

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	1200	V
I_C	Continuous collector current at $T_C = 25\text{ °C}$	30	A
I_C	Continuous collector current at $T_C = 100\text{ °C}$	15	A
$I_{CP}^{(1)}$	Pulsed collector current	60	A
V_{GE}	Gate-emitter voltage	± 20	V
I_F	Continuous forward current at $T_C = 25\text{ °C}$	30	A
I_F	Continuous forward current at $T_C = 100\text{ °C}$	15	A
$I_{FP}^{(1)}$	Pulsed forward current	60	A
P_{TOT}	Total dissipation at $T_C = 25\text{ °C}$	259	W
T_{STG}	Storage temperature range	- 55 to 150	°C
T_J	Operating junction temperature	- 55 to 175	°C

1. Pulse width limited by maximum junction temperature.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case IGBT	0.58	°C/W
R_{thJC}	Thermal resistance junction-case diode	1.3	°C/W
R_{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

$T_J = 25\text{ °C}$ unless otherwise specified

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 2\text{ mA}$	1200			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 15\text{ A}$		1.55	2.05	V
		$V_{GE} = 15\text{ V}, I_C = 15\text{ A}, T_J = 125\text{ °C}$		1.75		
		$V_{GE} = 15\text{ V}, I_C = 15\text{ A}, T_J = 175\text{ °C}$		1.85		
V_F	Forward on-voltage	$I_F = 15\text{ A}$		2.7	3.8	V
		$I_F = 15\text{ A}, T_J = 125\text{ °C}$		2.05		V
		$I_F = 15\text{ A}, T_J = 175\text{ °C}$		1.75		V
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 500\text{ }\mu\text{A}$	5	6	7	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 1200\text{ V}$			25	μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20\text{ V}$			250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz}, V_{GE} = 0$	-	981	-	pF
C_{oes}	Output capacitance		-	82	-	pF
C_{res}	Reverse transfer capacitance		-	37	-	pF
Q_g	Total gate charge	$V_{CC} = 960\text{ V}, I_C = 15\text{ A}, V_{GE} = 15\text{ V},$ see Figure 30	-	53	-	nC
Q_{ge}	Gate-emitter charge		-	7.8	-	nC
Q_{gc}	Gate-collector charge		-	28.2	-	nC

Table 6. IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 600\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 22\ \Omega$ see Figure 29	-	23	-	ns
t_r	Current rise time		-	10	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1200	-	A/ μ s
$t_{d(off)}$	Turn-off delay time		-	140	-	ns
t_f	Current fall time		-	282	-	ns
$E_{on}^{(1)}$	Turn-on switching losses		-	0.54	-	mJ
$E_{off}^{(2)}$	Turn-off switching losses		-	1.375	-	mJ
E_{ts}	Total switching losses	-	1.912	-	mJ	
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$, see Figure 29	-	22	-	ns
t_r	Current rise time		-	9.2	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	983	-	A/ μ s
$t_{d(off)}$	Turn-off delay time		-	146	-	ns
t_f	Current fall time		-	438	-	ns
$E_{on}^{(1)}$	Turn-on switching losses		-	0.923	-	mJ
$E_{off}^{(2)}$	Turn-off switching losses		-	1.85	-	mJ
E_{ts}	Total switching losses	-	2.772	-	mJ	
t_{sc}	Short-circuit withstand time	$V_{CC} \leq 600\text{ V}$, $V_{GE} = 15\text{ V}$, $T_{Jstart} \leq 150\text{ }^\circ\text{C}$, $V_P < 1200\text{ V}$	10		-	μ s

1. Energy losses include reverse recovery of the diode.
2. Turn-off losses also include the tail of the collector current.

Table 7. Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	$I_F = 15\text{ A}$, $V_R = 600\text{ V}$, $V_{GE} = 15\text{ V}$, see Figure 29 $di/dt = 1000\text{ A}/\mu\text{s}$	-	270	-	ns
Q_{rr}	Reverse recovery charge		-	960	-	nC
I_{rrm}	Reverse recovery current		-	15	-	A
dl_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	935	-	A/ μ s
E_{rr}	Reverse recovery energy		-	0.18	-	mJ
t_{rr}	Reverse recovery time	$I_F = 15\text{ A}$, $V_R = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$, see Figure 29 $di/dt = 1000\text{ A}/\mu\text{s}$	-	534	-	ns
Q_{rr}	Reverse recovery charge		-	3456	-	nC
I_{rrm}	Reverse recovery current		-	23	-	A
dl_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	266	-	A/ μ s
E_{rr}	Reverse recovery energy		-	0.55	-	mJ

3 Electrical characteristics curves

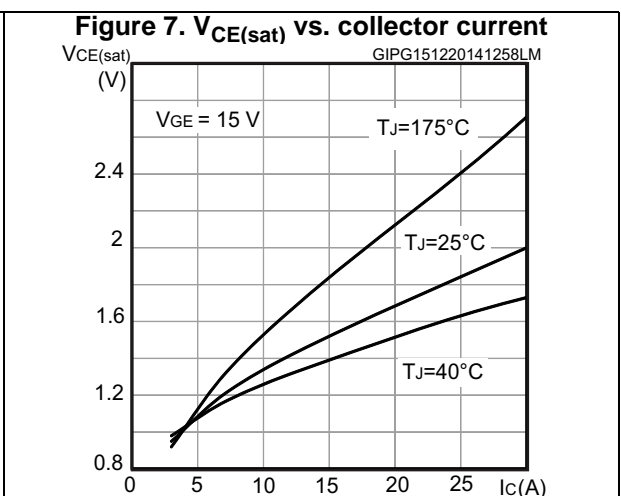
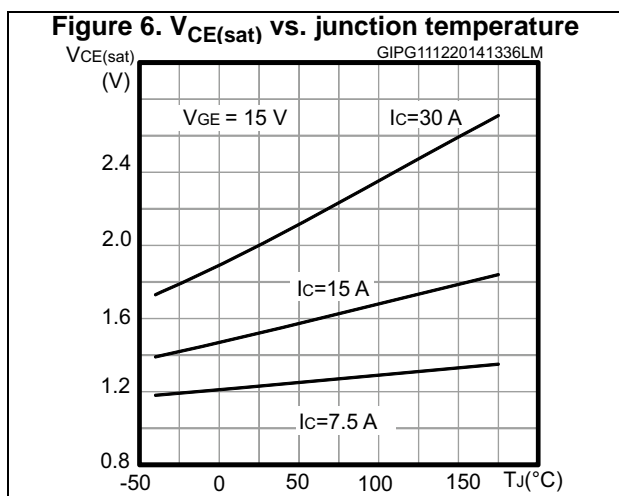
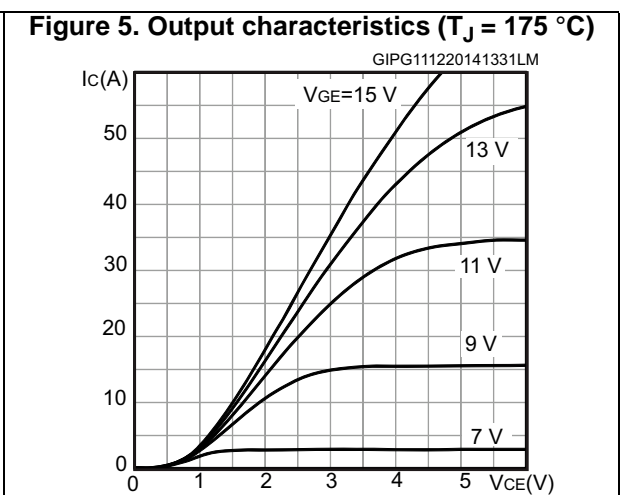
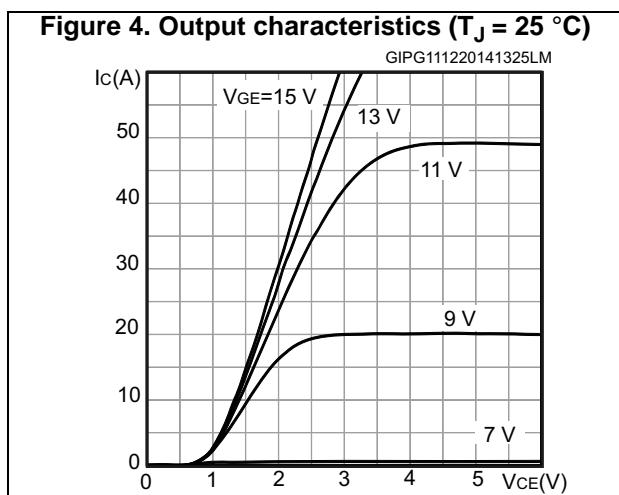
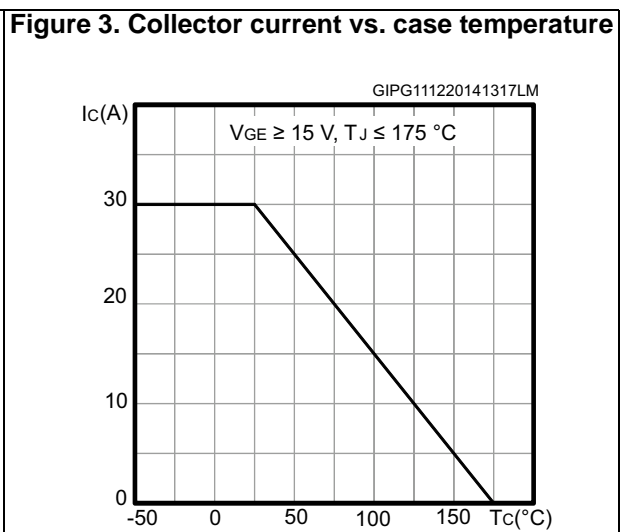
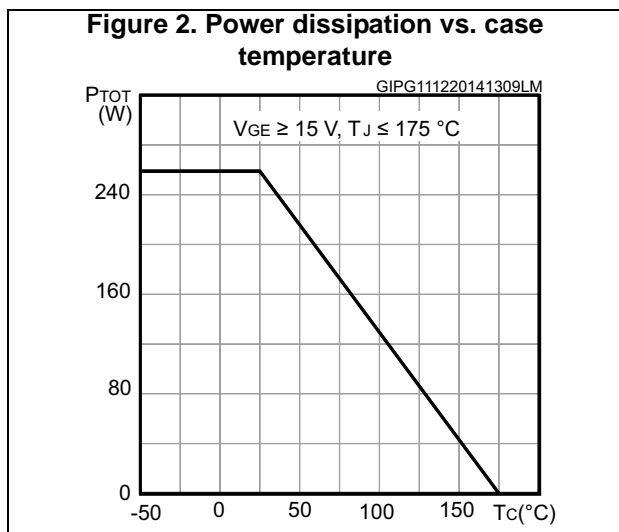


Figure 8. Collector current vs. switching frequency

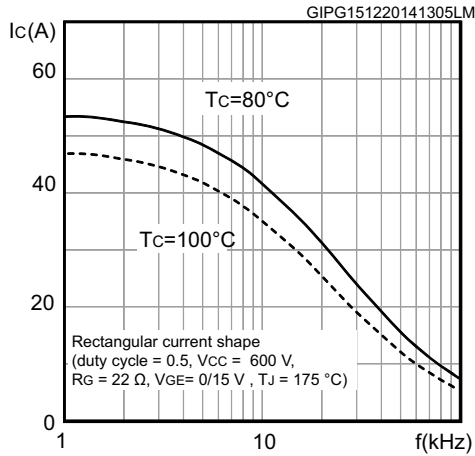


Figure 9. Forward bias safe operating area

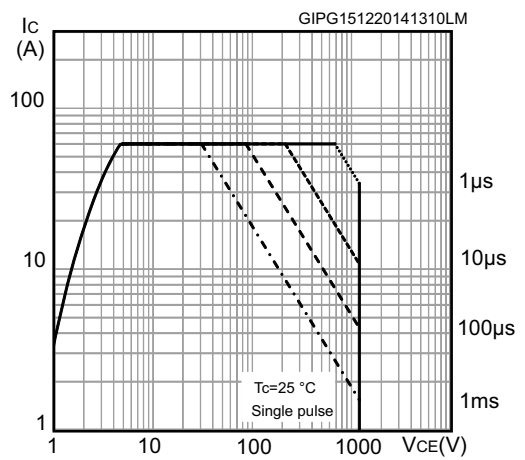


Figure 10. Transfer characteristics

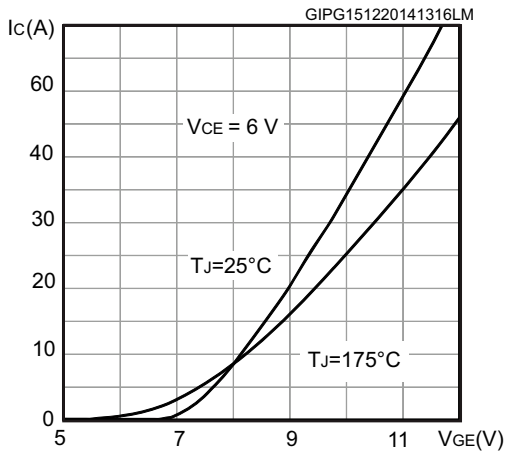


Figure 11. Diode VF vs. forward current

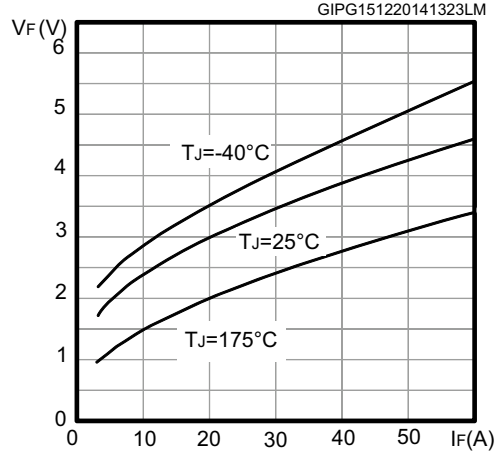


Figure 12. Normalized VGE(th) vs. junction temperature

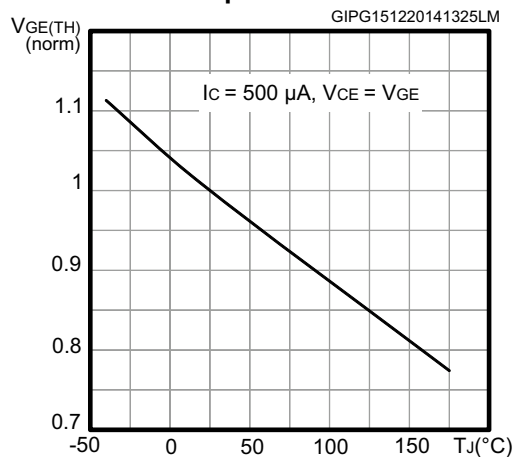
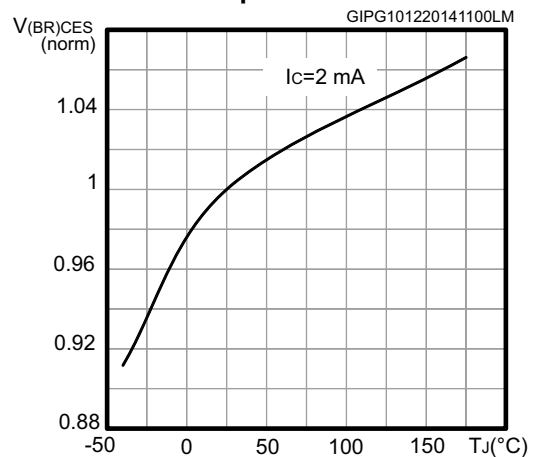


Figure 13. Normalized VBR(CES) vs. junction temperature



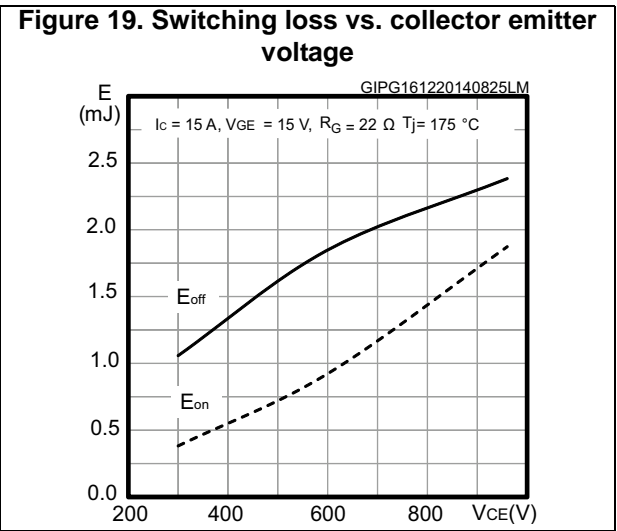
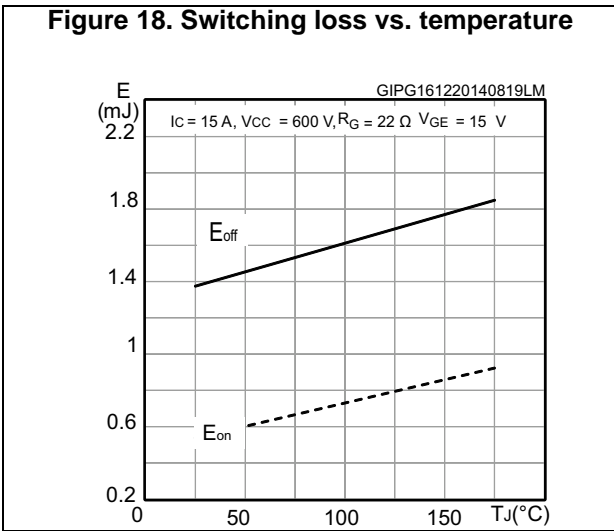
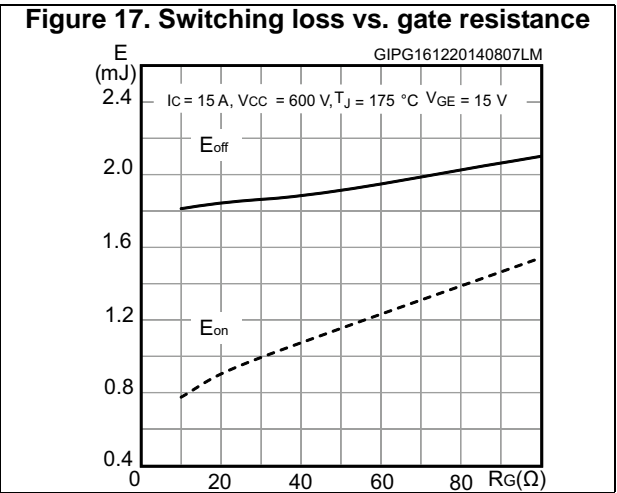
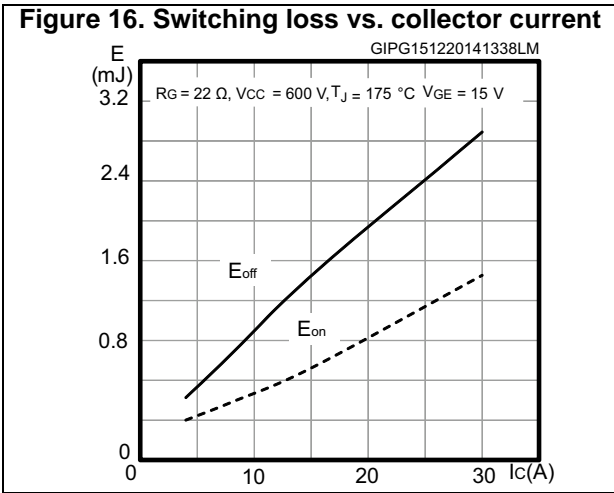
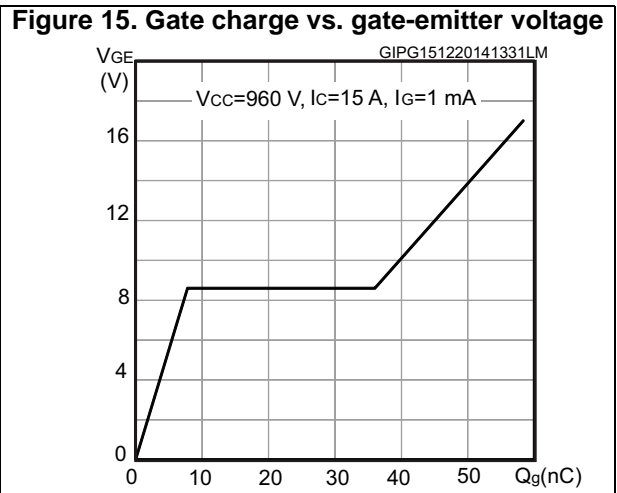
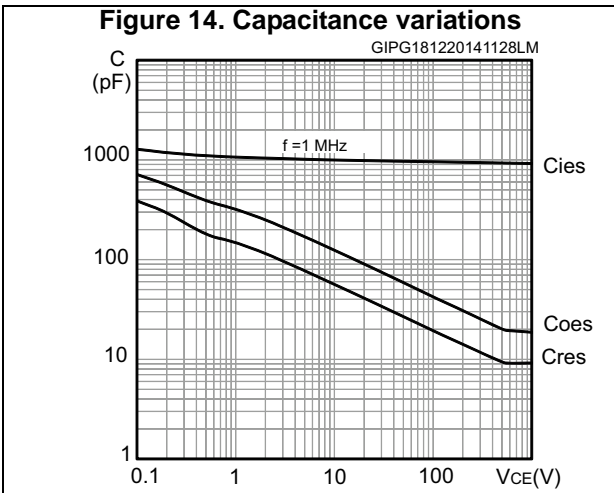


Figure 20. Short-circuit time and current vs V_{GE}

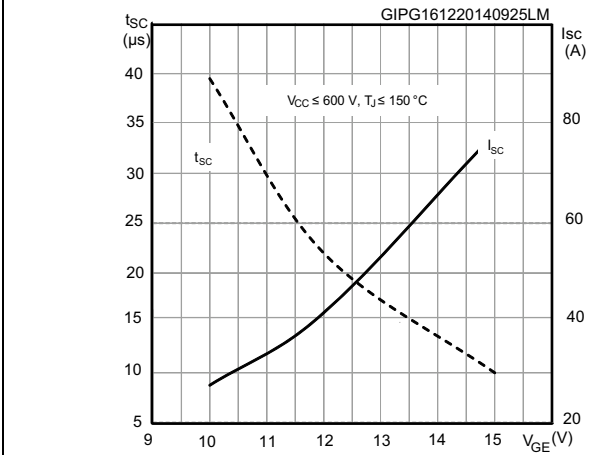


Figure 21. Switching times vs. collector current

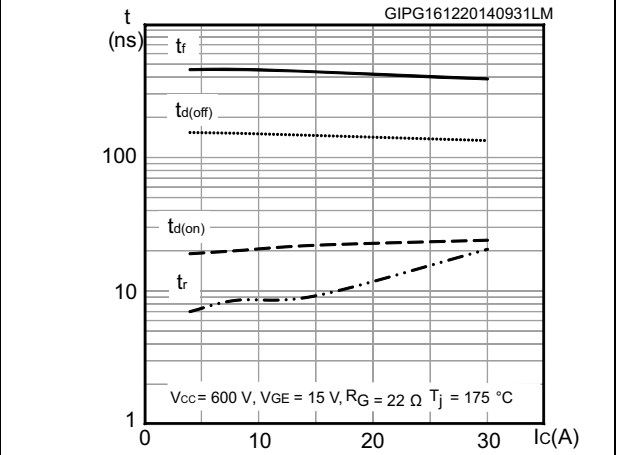


Figure 22. Switching times vs. gate resistance

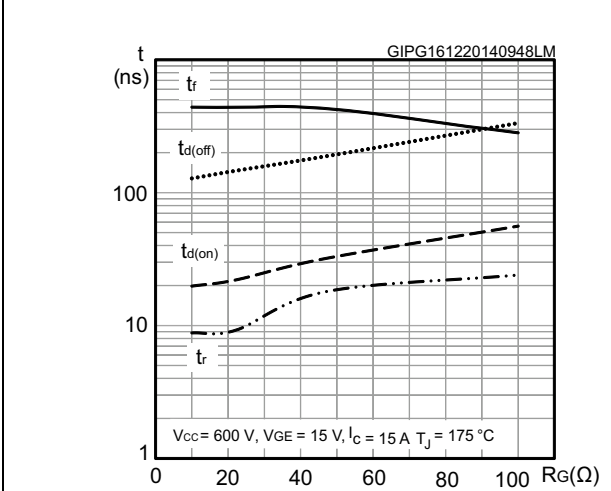


Figure 23. Reverse recovery current vs. diode current slope

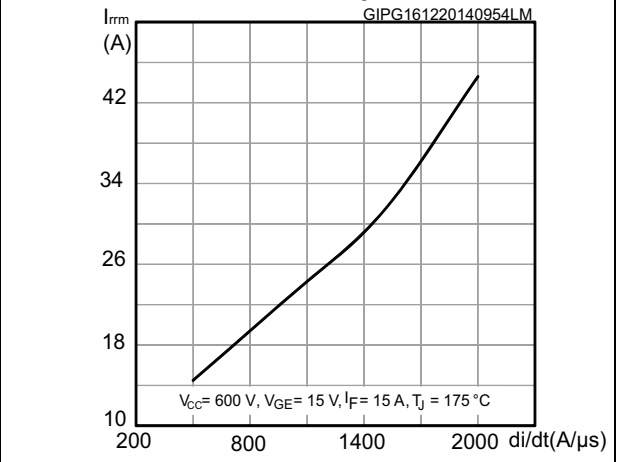


Figure 24. Reverse recovery time vs. diode current slope

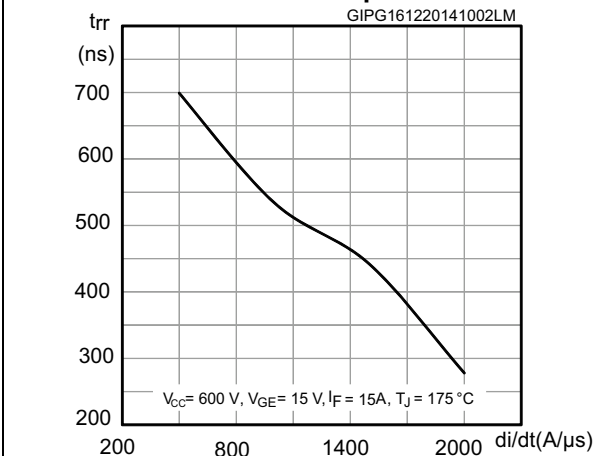
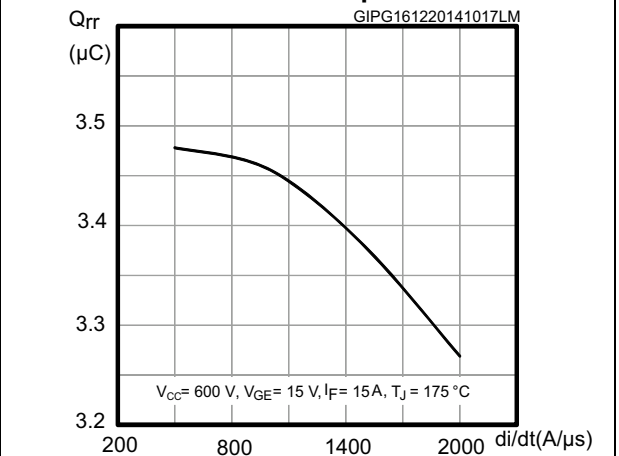


Figure 25. Reverse recovery charge vs. diode current slope



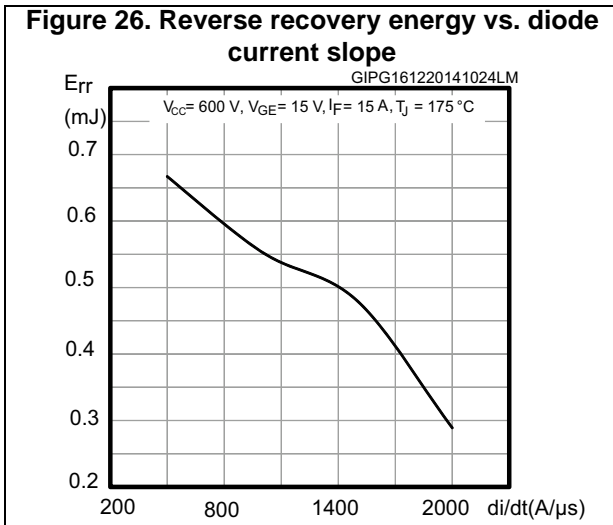


Figure 27. Thermal impedance for IGBT

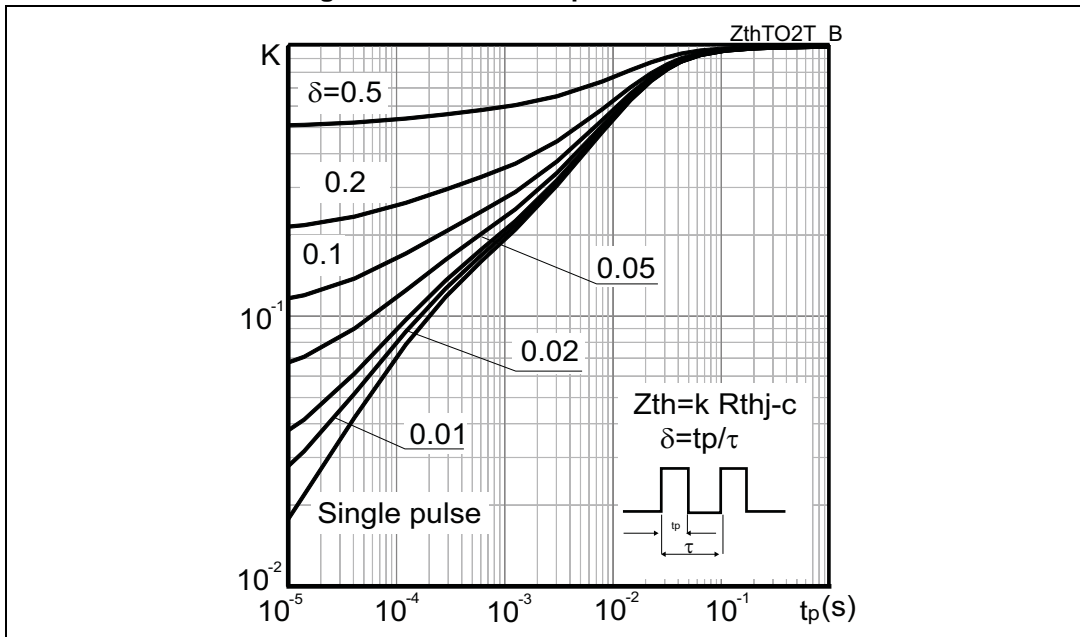
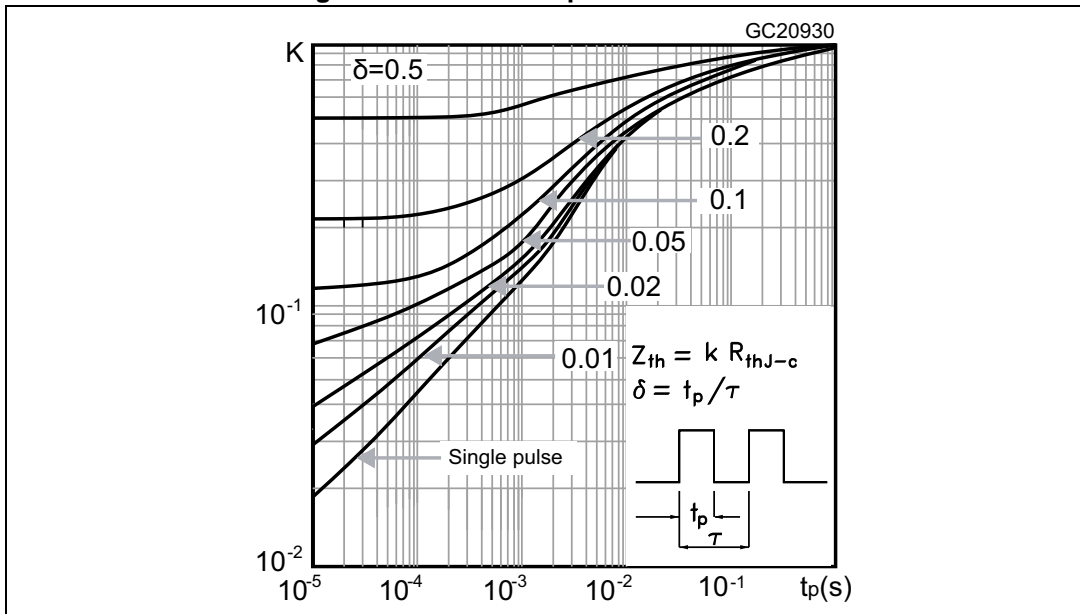
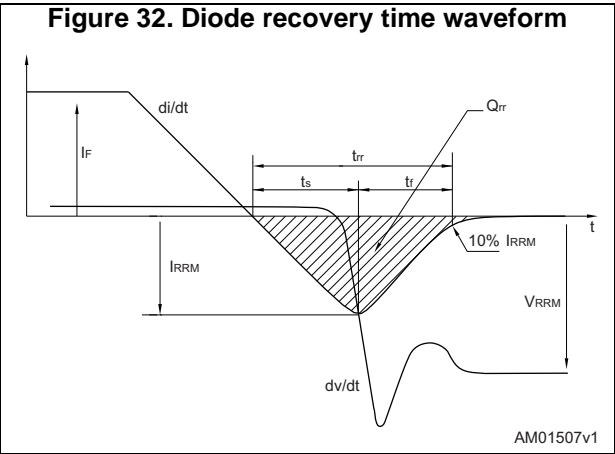
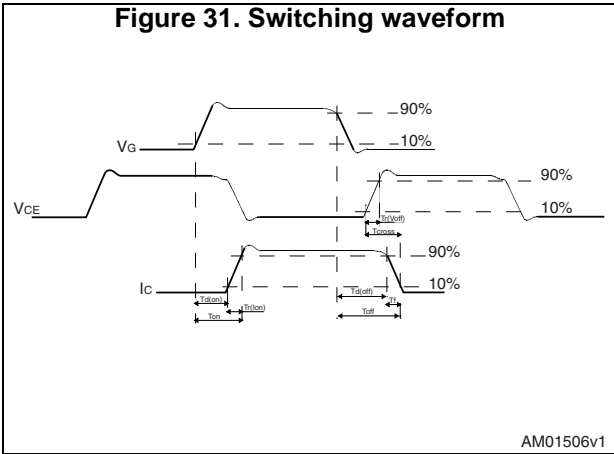
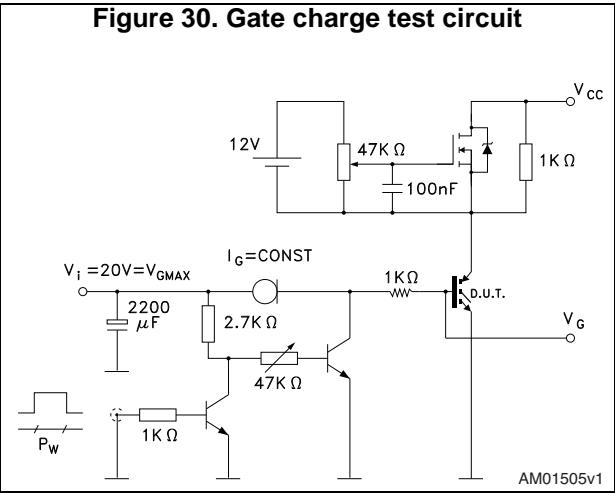
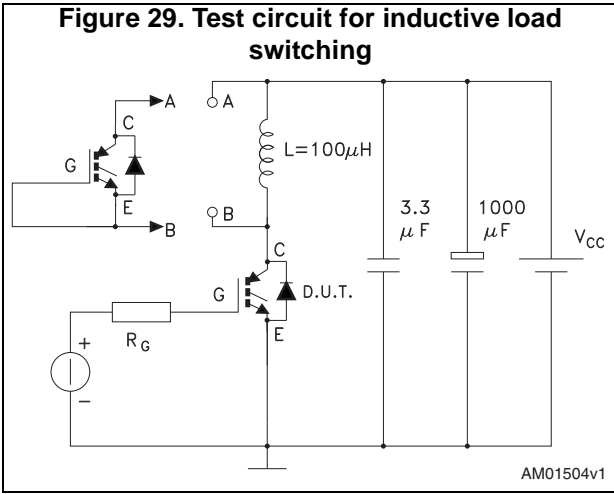


Figure 28. Thermal impedance for diode



4 Test circuits



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

5.1 TO-247, STGW15S120DF3

Figure 33. TO-247 outline

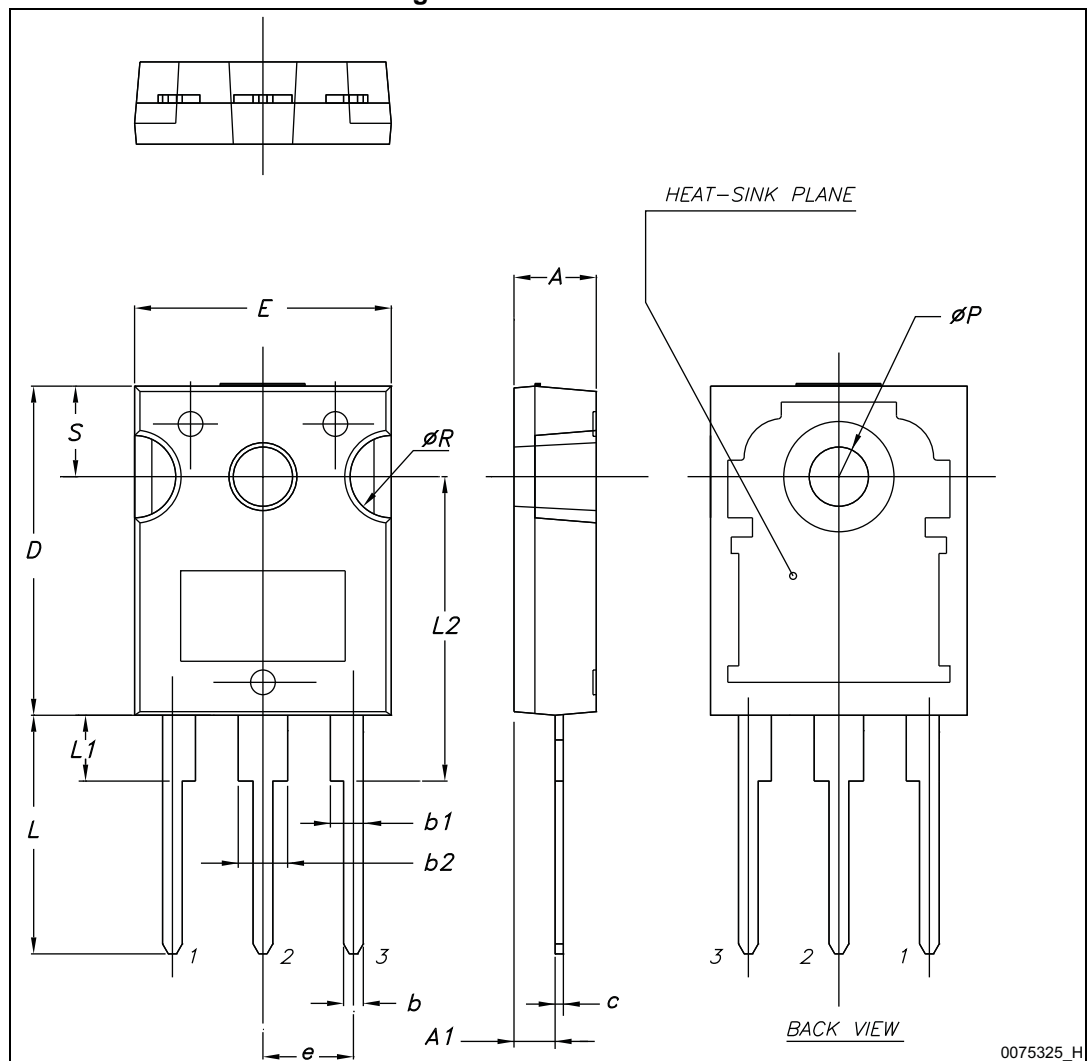


Table 8. TO-247 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

5.2 TO-247 long leads, STGWA15S120DF3

Figure 34. TO-247 long lead outline

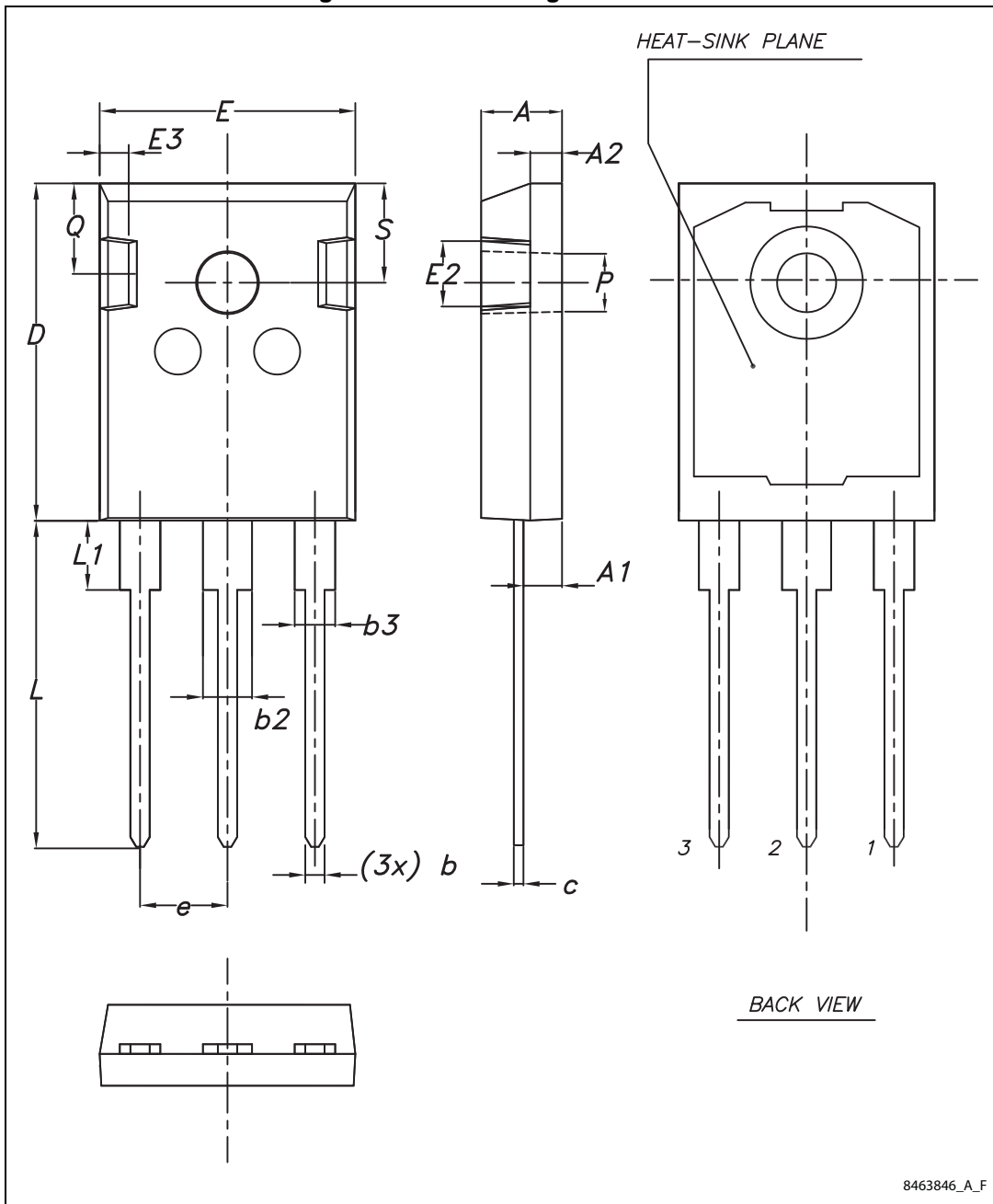


Table 9. TO-247 long leads mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

6 Revision history

Table 10. Document revision history

Date	Revision	Changes
16-May-2014	1	Initial release.
18-Dec-2014	2	Updated Section 1 and Section 2 . Inserted Section 3 .

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